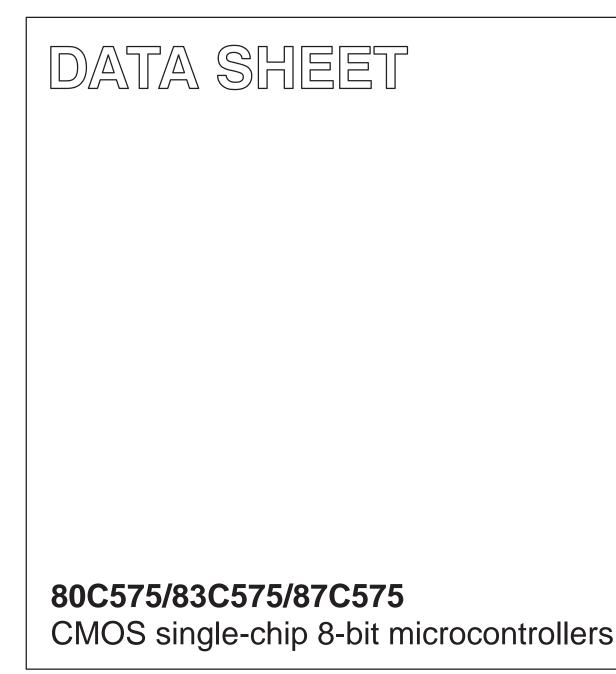
INTEGRATED CIRCUITS



Product specification

IC20 Data Handbook

1998 Jan 27

PHILIPS PHILIPS

DESCRIPTION

The Philips 80C575/83C575/87C575 is a high-performance microcontroller fabricated with Philips high-density CMOS technology. The Philips CMOS technology combines the high speed and density characteristics of HMOS with the low power attributes of CMOS. Philips epitaxial substrate minimizes latch-up sensitivity.

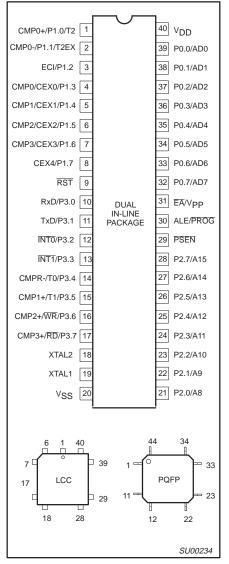
The 8XC575 contains an $8k \times 8$ ROM (83C575) EPROM (87C575), a 256×8 RAM, 32 I/O lines, three 16-bit counter/timers, a Programmable Counter Array (PCA), a seven-source, two-priority level nested interrupt structure, an enhanced UART, four analog comparators, power-fail detect and oscillator fail detect circuits, and on-chip oscillator and clock circuits.

In addition, the 8XC575 has a low active reset, and the port pins are reset to a low level. There is also a fully configurable watchdog timer, and internal power on clear circuit. The part includes idle mode and power-down mode states for reduced power consumption.

FEATURES

- 80C51 based architecture
 - 8k × 8 ROM (83C575)
 - 8k × 8 EPROM (87C575)
 - ROMless (80C575)
 - 256 × 8 RAM
 - Three 16-bit counter/timers
 - Programmable Counter Array
 - Enhanced UART
 - Boolean processor
 - Oscillator fail detect
 - Low active reset
 - Asynchronous low port reset
 - Schmitt trigger inputs
 - 4 analog comparators
 - Watchdog timer
 - Low V_{CC} detect
- Memory addressing capability
- 64k ROM and 64k RAM
- Power control modes:
 - Idle mode
- Power-down mode
- CMOS and TTL compatible
- 4.0 to 16MHz
- Extended temperature ranges
- OTP package available

PIN CONFIGURATIONS



ORDERING INFORMATION

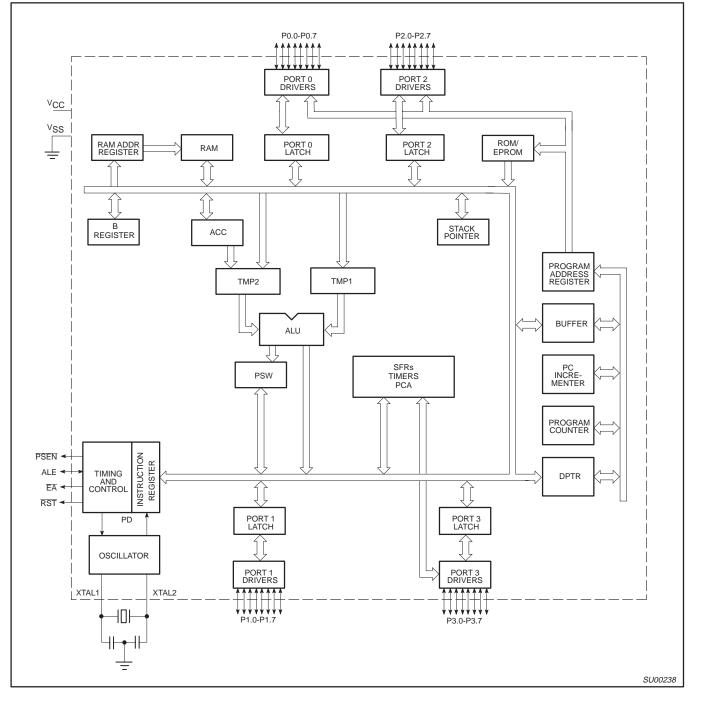
ROMIess	ROM	EPROM ¹		TEMPERATURE RANGE °C AND PACKAGE	FREQ (MHz)	DRAWING NUMBER
P80C575EBPN	P83C575EBPN	P87C575EBPN	OTP	0 to +70, 40-Pin Plastic Dual In-line Package	16	SOT129-1
P80C575EBAA	P83C575EBAA	P87C575EBAA	OTP	0 to +70, 44-Pin Plastic Leaded Chip Carrier	16	SOT187-2
P80C575EHAA	P83C575EHAA	P87C575EHAA	OTP	-40 to +125, 44-Pin Plastic Leaded Chip Carrier	16	SOT187-2
P80C575EBBB	P83C575EBBB	P87C575EBBB	OTP	0 to +70, 44-Pin Plastic Quad Flat Pack	16	SOT307-2

NOTE:

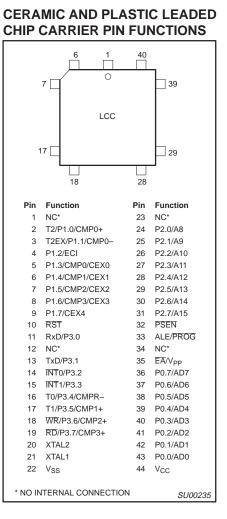
1. OTP - One Time Programmable EPROM.

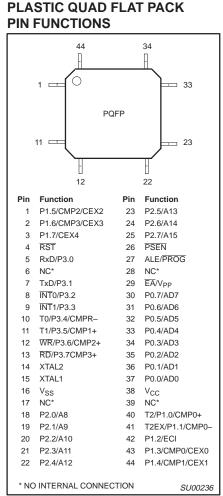
80C575/83C575/87C575

BLOCK DIAGRAM

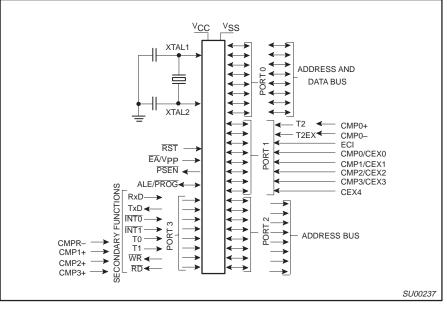


80C575/83C575/87C575





LOGIC SYMBOL



80C575/83C575/87C575

PIN DESCRIPTIONS

	PI	NUMB	ER						
MNEMONIC	DIP	LCC	QFP	TYPE	NAME AND FU	INCTION			
V _{SS}	20	22	16	I	Ground: 0V ref	erence.			
V _{CC}	40	44	38	I	Power Supply: operation.	This is the power supply voltage for normal, idle, and power-down			
P0.0-0.7	39-32	43-36	37-30	I/O	float and can be address and da application, it us bytes during EF External pull-up asynchronously have Schmitt tri	s an open-drain bidirectional I/O port. Port 0 pins that have 1s written to them a used as high-impedance inputs. Port 0 is also the multiplexed low-order ta bus during accesses to external program and data memory. In this ses strong internal pull-ups when emitting 1s. Port 0 also receives code PROM programming and outputs code bytes during program verification. It is are required during program verification. During reset, port 0 will be of driven low and will remain low until written to by software. All port 0 pins gger inputs with 200mV hysteresis. A weak pulldown on port 0 guarantees a current (see DC Electrical Characteristics: I_{L1}).			
P1.0-P1.7	1-8	2-9	40-44 1-3	I/O	pins that have 1 externally pulled address byte du port 1 will be as	s an 8-bit bidirectional I/O port. Port 1 pins have internal pull-ups such that s written to them can be used as inputs but will source current when d low (see DC Electrical Characteristics: I_{IL}). Port 1 receives the low-order uring program memory verification and EPROM programming. During reset, synchronously driven low and will remain low until written to by software. All e Schmitt trigger inputs with 50mV hysteresis. Port 1 pins also serve bons as follows:			
	1	2	40	I/O	P1.0 T2 CMP0+	Timer 2 external I/O – clockout (programmable) Comparator 0 positive input			
	2	3	41	I	P1.1 T2EX CMP0-	Timer 2 capture input Comparator 0 negative input			
	3	4	42	I.	P1.2 ECI	PCA count input			
	4	5	43	I/O	P1.3 CEX0 CMP0	PCA module 0 external I/O Comparator 0 output			
	5	6	44	I/O	P1.4 CEX1 CMP1	PCA module 1 external I/O Comparator 1 output			
	6	7	1	I/O	P1.5 CEX2 CMP2	PCA module 2 external I/O Comparator 2 output			
	7	8	2	I/O	P1.6 CEX3 CMP3	PCA module 3 external I/O Comparator 3 output			
	8	9	3	I/O	P1.7 CEX4	PCA module 4 external I/O			
P2.0-P2.7	21-28	24-31	18-25	I/O	written to them (see DC Electri accesses to ext @DPTR). In thi receives the hig During reset, po software. Port	s an 8-bit bidirectional I/O port with internal pull-ups. Port 2 pins that have 1s can be used as inputs, but will source current when externally pulled low cal Characteristics: I_{IL}). Port 2 emits the high-order address byte during ernal program and data memory that use 16-bit addresses (MOVX s application, it uses strong internal pull-ups when emitting 1s. Port 2 h-order address byte during program verification and EPROM programming. prt 2 will be asynchronously driven low and will remain low until written to by 2 can be made open drain by writing to the P2OD register (AIH). In open ak pulldowns on port 2 guarantee positive leakage current (see DC acteristics I_{L1}).			
P3.0-P3.7	10-17	11, 13-19	5, 7-13	I/O	that have 1s wr pulled low (see while transmittin when outputting two levels by th asynchronously have Schmitt tri	s an 8-bit bidirectional I/O port with internal pull-ups. Port 3 pins except P3.1 itten to them can be used as inputs but will source current when externally DC Electrical Characteristics: I_{IL}). P3.1 will be a high impedance pin except ng serial data, in which case the strong pull-up will remain on continuously a 1 level. The P3.1 output drive level when transmitting can be set to one of e writing to the P3.1 register bit. During reset all pins (except P3.1) will be driven low and will remain low until written to by software. All port 3 pins gger inputs with 200mV hysteresis, except P3.2 and P3.3, which have 50mV : 3 pins serve alternate functions as follows:			

80C575/83C575/87C575

PIN DESCRIPTIONS (Continued)

	PIN		ER		
MNEMONIC	DIP	LCC	QFP	TYPE	NAME AND FUNCTION
					Port 3: (continued)
	10	11	5	1	P3.0 RxD Serial receive port
	11	13	7	0	P3.1 TxD Serial transmit port enabled only when transmitting serial data
	12	14	8		P3.2 INTO External interrupt 0
	13	15	9	1	P3.3 INT1 External interrupt 1
	14	16	10	I	P3.4 T0 Timer/counter 0 input CMPR- Common - reference to comparators 1, 2, 3
	15	17	11	I	P3.5 T1 Timer/counter 1 input CMP1+ Comparator 1 positive input
	16	18	12	0	P3.6 WR External data memory write strobe CMP2+ Comparator 2 positive input
	17	19	13	0	P3.7 RD External data memory read strobe CMP3+ Comparator 3 positive input
RST	9	10	4	I	Reset: A low on this pin asynchronously resets all port pins to a low state except P3.1. The pin must be held low with the oscillator running for 24 oscillator cycles to initialize the internal registers. An internal diffused resistor to V_{CC} permits a power on reset using only an external capacitor to V_{SS} . RST has a Schmitt trigger input stage to provide additional noise immunity with a slow rising input voltage.
ALE/PROG	30	33	27	I/O	Address Latch Enable/Program Pulse: Output pulse for latching the low byte of the address during an access to external memory. In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency, and can be used for external timing or clocking. Note that one ALE pulse is skipped during each access to external data memory. ALE is switched off if the bit 0 in the AUXR register (8EH) is set. This pin is also the program pulse input (PROG) during EPROM programming.
PSEN	29	32	26	0	Program Store Enable: The read strobe to external program memory. When the device is executing code from the external program memory, PSEN is activated twice each machine cycle, except that two PSEN activations are skipped during each access to external data memory. PSEN is not activated during fetches from internal program memory.
EA/V _{PP}	31	35	29	I	External Access Enable/Programming Supply Voltage: EA must be externally held low to enable the device to fetch code from external program memory locations 0000H to 1FFFH. If EA is held high, the device executes from internal program memory unless the program counter contains an address greater than 1FFFH. This pin also receives the 12.75V programming supply voltage (V _{PP}) during EPROM programming.
XTAL1	19	21	15	I	Crystal 1: Input to the inverting oscillator amplifier and input to the internal clock generator circuits.
XTAL2	18	20	14	0	Crystal 2: Output from the inverting oscillator amplifier.

80C575/83C575/87C575

Table 1.	87C575 Special Function Registers
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SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT A MSB	DDRESS	, SYMBO	L, OR ALT	ERNATIV	E PORT	FUNCTIC	N LSB	RESET VALUE
ACC*	Accumulator	E0H	E7	E6	E5	E4	E3	E2	E1	E0	00H
AUXR#	Auxiliary	8EH	-	-	-	-	-	-	LO	AO	xxxxxx00B
B*	B register	F0H	F7	F6	F5	F4	F3	F2	F1	F0	оон
CCAP0H#	Module 0 Capture High	FAH									xxxxxxxB
CCAP1H#	Module 1 Capture High	FBH									XXXXXXXXB
CCAP2H#	Module 2 Capture High	FCH									xxxxxxxB
CCAP3H#	Module 3 Capture High	FDH									xxxxxxxB
CCAP4H#	Module 4 Capture High	FEH									xxxxxxxB
CCAP0L#	Module 0 Capture Low	EAH									xxxxxxxB
CCAP1L#	Module 1 Capture Low	EBH									xxxxxxxB
CCAP2L#	Module 2 Capture Low	ECH									xxxxxxxB
CCAP3L#	Module 3 Capture Low	EDH									xxxxxxxB
CCAP4L#	Module 4 Capture Low	EEH									xxxxxxxB
CCAPM0#	Module 0 Mode	DAH	-	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
CCAPM1#	Module 1 Mode	DBH	-	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x000000B
CCAPM2#	Module 2 Mode	DCH	-	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x000000B
CCAPM3#	Module 3 Mode	DDH	-	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x000000B
CCAPM4#	Module 4 Mode	DEH	-	ECOM	CAPP	CAPN	MAT	TOG	PWM	ECCF	x0000000B
			DF	DE	DD	DC	DB	DA	D9	D8	
CCON*#	PCA Counter Control	D8H	CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0	00x00000B
CH#	PCA Counter High	F9H		_							00H
CL#	PCA Counter Low	E9H									00H
CMOD#	PCA Counter Mode	D9H	CIDL	WDTE	-	-	-	CPS1	CPS0	ECF	00xxx000B
			EF	EE	ED	EC	EB	EA	E9	E8	
CMP*#	Comparator	E8H	EC3DP	EC2DP	EC1DP	EC0DP	C3RO	C2RO	C1RO	CORO	00Н
CMPE#	Comparator Enable	91H	EC3TDC	EC2TDC	EC1TDC	ECOTDC	EC30D	EC2OD	EC10D	EC0OD	00Н
DPTR: DPH DPL	Data Pointer (2 bytes) Data Pointer High Data Pointer Low	83H 82H									00H 00H
			AF	AE	AD	AC	AB	AA	A9	A8	
IE*	Interrupt Enable	A8H	EA	EC	ET2	ES	ET1	EX1	ET0	EX0	00H
			BF	BE	BD	BC	BB	BA	B9	B8	1
IP*	Interrupt Priority	B8H	-	PPC	PT2	PS	PT1	PX1	PT0	PX0	x0000000B
			87	86	85	84	83	82	81	80	
P0*	Port 0	80H	AD7	AD6	AD5	AD4	AD3	AD2	AD1	AD0	оон
			97	96	95	94	93	92	91	90	1
P1*	Port 1	90H	CEX4	CEX3	CEX2	CEX1	CEX0	EXI	T2EX	T2	00H
			A7	A6	A5	A4	A3	A2	A1	A0	
P2*	Port 2	A0H	AD15	AD14	AD13	AD12	AD11	AD10	AD9	AD8	00H
			B7	B6	B5	B4	B3	B2	B1	B0	
P3*	Port 3	B0H	RD	WR	T1	Т0	INT1	INTO	TxD	RxD	00H

* SFRs are bit addressable.
SFRs are modified from or added to the 80C51 SFRs.
1. 87C575 only.

80C575/83C575/87C575

SYMBOL	DESCRIPTION	DIRECT ADDRESS	BIT / MSB	ADDRESS	, SYMBO	L, OR AL	TERNATIV	E PORT	FUNCTIO	N LSB	RESET VALUE
P2OD#	Port 2 Pullup Disable	A1H									00H
PCON#	Power Control	87H	SMOD1	SMOD0	OSF ¹	POF ¹	LVF ¹	GF0	PD	IDL	00xxx000B
			D7	D6	D5	D4	D3	D2	D1	D0	
PSW*	Program Status Word	D0H	CY	AC	F0	RS1	RS0	OV	-	Р	00H
RACAP2H# RACAP2L#	Timer 2 Capture High Timer 2 Capture Low	CBH CAH									00H 00H
SADDR# SADEN#	Slave Address Slave Address Mask	A9H B9H									00H 00H
SBUF	Serial Data Buffer	99H									xxxxxxxB
0000		0.011	9F	9E	9D	9C	9B	9A	99	98	0.011
SCON* SP	Serial Control Stack Pointer	98H	SM0	SM1	SM2	REN	TB8	RB8	ΤI	RI	00H 07H
38	Slack Pointer	81H	8F	8E	8D	8C	8B	8A	89	88	0/11
TCON*	Timer Control	88H	TF1	TR1	TF0	TR0	IE1	IT1	IE0	ITO	00H
1001		0011			110	1110			120	110	0011
			CF	CE	CD	СС	СВ	CA	C9	C8	
T2CON*	Timer 2 Control	C8H	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2	00H
T2MOD#	Timer 2 Mode Control	C9H	-	-	-	-	-	_	T2OE ²	DCEN	xxxxxxx0B
TH0 TH1 TH2# TL0 TL1 TL2#	Timer High 0 Timer High 1 Timer High 2 Timer Low 0 Timer Low 1 Timer Low 2	8CH 8DH CDH 8AH 8BH CCH									00H 00H 00H 00H 00H 00H
TMOD	Timer Mode	89H	GATE	C/T	M1	M0	GATE	C/T	M1	MO	00H
			C7	C6	C5	C4	C3	C2	C1	C0	
WDCON*#	Watchdog Timer Control	C0H	PRE2	PRE1	PRE0	LVRE	OFRE	WDRUN	WDTOF	WDMOD	11111101B
WDL# WFEED1# WFEED2#	Watchdog Timer Reload Watchdog Feed 1 Watchdog Feed 2	C1H C2H C3H									00H xxH xxH

Table 1.	87C575 Sj	pecial Function	Registers ((Continued)	1
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*

SFRs are bit addressable. SFRs are modified from or added to the 80C51 SFRs. #

Reset value depends on reset source.
 Programmable clock-out.

80C575/83C575/87C575

POWER ON CLEAR/ POWER ON FLAG

An on-chip Power On Detect Circuit resets the 8XC575 and sets the Power Off Flag (PCON.4) on power up or if V_{CC} drops to zero momentarily. The POF can only be cleared by software. The RST pin is not driven by the power on detect circuit. The POF can be read by software to determine that a power failure has occurred and can also be set by software.

LOW VOLTAGE DETECT

An on-chip Low Voltage Detect circuit sets the Low Voltage Flag (PCON.3) if V_{CC} drops below V_{LOW} (see DC Electrical Characteristics) and resets the 8XC575 if the Low Voltage Reset Enable bit (WDCON.4) is set. If the LVRE is cleared, the reset is disabled but LVF will still be set if V_{CC} is low. The RST pin is not driven by the low voltage detect circuit. The LVF can be read by software to determine that V_{CC} was low. The LVF can be set or cleared by software.

OSCILLATOR FAIL DETECT

An on-chip Oscillator Fail Detect circuit sets the Oscillator Fail Flag (PCON.5) if the oscillator frequency drops below OSCF for one or more cycles (see AC Electrical Characteristics: OSCF) and resets the 8XC575 if the Oscillator Fail Reset Enable bit (WDCON.3) is set. If OFRE is cleared, the reset is disabled but OSF will still be set if the oscillator fails. The RST pin is not driven by the oscillator fail detect circuit. The OSF can be read by software to determine that an oscillator failure has occurred. The OSF can be set or cleared by software.

LOW ACTIVE RESET

One of the most notable features on this part is the low active reset. At this time this is the only 80C51 derivative available that has low active reset. This feature makes it easier to interface the 8XC575 into an application to accommodate the power-on and low voltage conditions that can occur. The low active reset operates exactly the same as high active reset with the exception that the part is put into the reset mode by applying a low level to the reset pin. For power-on reset it is also necessary to invert the power-on reset circuit; connecting the 8.2K resistor from the reset pin to V_{CC} and the 10µf capacitor from the reset pin to ground. Figure 1 shows all of the reset related circuitry.

When reset the port pins on the 87C575 are driven low asynchronously. This is different from all other 80C51 derivatives.

The 8XC575 also has Low voltage detection circuitry that will, if enabled, force the part to reset when V_{CC} (on the part) fails below a set level. Low Voltage Reset is enabled by a normal reset. Low Voltage Reset can be disabled by clearing LVRE (bit 4 in the WDCON SFR) then executing a watchdog feed sequence (A5H to WFEED1 followed immediately by 5A to WFEED2). In addition there is a flag (LVF) that is set if a low voltage condition is detected. The LVF flag is set even if the Low Voltage detection circuitry is disabled. Notice that the Low voltage detection circuitry does not drive the RST# pin so the LVF flag is the only way that the microcontroller can determine if it has been reset due to a low voltage condition.

The 8XC575 has an on-chip power-on detection circuit that sets the POF (PCON.4) flag on power up or if the V_{CC} level momentarily drops to 0V. This flag can be used to determine if the part is being started from a power-on (cold start) or if a reset has occurred due to another condition (warm start).

TIMERS

The 87C575 has four on-chip timers.

Timers 0 and 1 are identical in every way to Timers 0 and 1 on the 80C51.

Timer 2 on the 8XC575 is identical to the 80C52 Timer 2 (described in detail in the 80C52 overview) with the exception that it is an up or down counter. To configure the Timer to count down the DCEN bit in the T2MOD special function register must be set and a low level must be present on the T2EX pin (P1.1).

The Watchdog timer operation and implementation is the same as that for the 8XC550 (described in the 8XC550 overview) with the exception that the reset values of the WDCON and WDL special function registers have been changed. The changes in these registers cause the watchdog timer to be enabled with a timeout of $98304 \times T_{OSC}$ when the part is reset. The watchdog can be disabled by executing a valid feed sequence and then clearing WDRUN (bit 2 in the WDCON SFR).

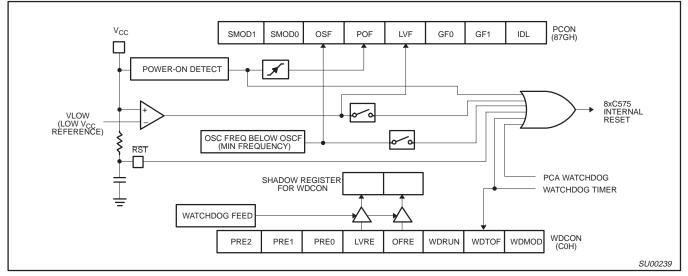


Figure 1. Reset Circuitry

PROGRAMMABLE COUNTER **ARRAY (PCA)**

The Programmable Counter Array is a special Timer that has five 16-bit capture/compare modules associated with it. Each of the modules can be programmed to operate in one of four modes: rising and/or falling edge capture, software timer, high-speed output, or pulse width modulator. Each module has a pin associated with it in port 1. Module 0 is connected to P1.3(CEX0), module 1 to P1.4(CEX1), etc.. The basic PCA configuration is shown in Figure 2.

The PCA timer is a common time base for all five modules and can be programmed to run at: 1/12 the oscillator frequency, 1/4 the oscillator frequency, the Timer 0 overflow, or the input on the ECI pin (P1.2). The timer count source is determined from the CPS1 and CPS0 bits in the CMOD SFR as follows (see Figure 3):

CPS1 CPS0 PCA Timer Count Source

-		
0	0	1/12 oscillator frequency
0	1	1/4 oscillator frequency

1	1/4 oscillator frequency
1	1/4 Uscillator frequency

1

- 0 Timer 0 overflow
- External Input at ECI pin

In the CMOD SFR are three additional bits associated with the PCA. They are CIDL which allows the PCA to stop during idle mode, WDTE which enables or disables the watchdog function on module 4, and ECF which when set causes an interrupt and the PCA overflow flag CF (in the CCON SFR) to be set when the PCA timer overflows. These functions are shown in Figure 3.

The watchdog timer function is implemented in module 4 as implemented in other parts that have a PCA that are available on the market. However, if a watchdog timer is required in the target application, it is recommended to use the hardware watchdog timer that is implemented on the 87C575 separately from the PCA (see Figure 14).

The CCON SFR contains the run control bit for the PCA and the flags for the PCA timer (CF) and each module (refer to Figure 6). To run the PCA the CR bit (CCON.6) must be set by software. The PCA is shut off by clearing this bit. The CF bit (CCON.7) is set when the PCA counter overflows and an interrupt will be generated if the ECF bit in the CMOD register is set, The CF bit can only be cleared by software. Bits 0 through 4 of the CCON register are the flags for the modules (bit 0 for module 0, bit 1 for module 1, etc.) and are set by hardware when either a match or a capture occurs. These flags also can only be cleared by software. The PCA interrupt system shown in Figure 4.

Each module in the PCA has a special function register associated with it. These registers are: CCAPM0 for module 0, CCAPM1 for module 1, etc. (see Figure 7). The registers contain the bits that control the mode that each module will operate in. The ECCF bit (CCAPMn.0 where n=0, 1, 2, 3, or 4 depending on the module) enables the CCF flag in the CCON SFR to generate an interrupt when a match or compare occurs in the associated module. PWM (CCAPMn.1) enables the pulse width modulation mode. The TOG bit (CCAPMn.2) when set causes the CEX output associated with the module to toggle when there is a match between the PCA counter and the module's capture/compare register. The match bit MAT (CCAPMn.3) when set will cause the CCFn bit in the CCON register to be set when there is a match between the PCA counter and the module's capture/compare register.

The next two bits CAPN (CCAPMn.4) and CAPP (CCAPMn.5) determine the edge that a capture input will be active on. The CAPN bit enables the negative edge, and the CAPP bit enables the positive edge. If both bits are set both edges will be enabled and a capture will occur for either transition. The last bit in

the register ECOM (CCAPMn.6) when set enables the comparator function. Figure 8 shows the CCAPMn settings for the various PCA functions.

There are two additional registers associated with each of the PCA modules. They are CCAPnH and CCAPnL and these are the registers that store the 16-bit count when a capture occurs or a compare should occur. When a module is used in the PWM mode these registers are used to control the duty cycle of the output.

PCA Capture Mode

To use one of the PCA modules in the capture mode either one or both of the CCAPM bits CAPN and CAPP for that module must be set. The external CEX input for the module (on port 1) is sampled for a transition. When a valid transition occurs the PCA hardware loads the value of the PCA counter registers (CH and CL) into the module's capture registers (CCAPnL and CCAPnH). If the CCFn bit for the module in the CCON SFR and the ECCFn bit in the CCAPMn SFR are set then an interrupt will be generated. Refer to Figure 9.

16-bit Software Timer Mode

The PCA modules can be used as software timers by setting both the ECOM and MAT bits in the modules CCAPMn register. The PCA timer will be compared to the module's capture registers and when a match occurs an interrupt will occur if the CCFn (CCON SFR) and the ECCFn (CCAPMn SFR) bits for the module are both set (see Figure 10).

High Speed Output Mode

In this mode the CEX output (on port 1) associated with the PCA module will toggle each time a match occurs between the PCA counter and the module's capture registers. To activate this mode the TOG, MAT, and ECOM bits in the module's CCAPMn SFR must be set (see Figure 11).

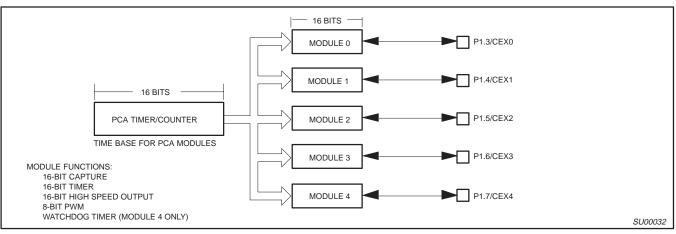


Figure 2. Programmable Counter Array (PCA)

Philips Semiconductors

80C575/83C575/87C575

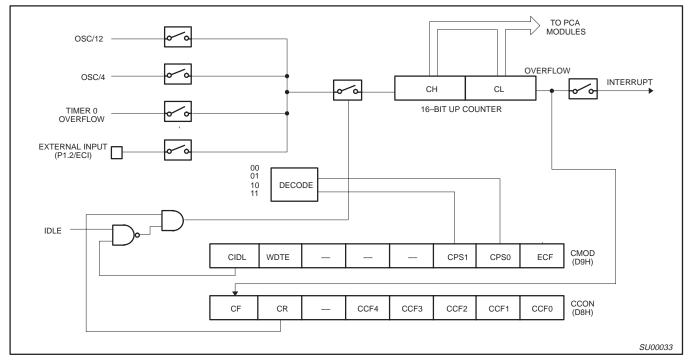


Figure 3. PCA Timer/Counter

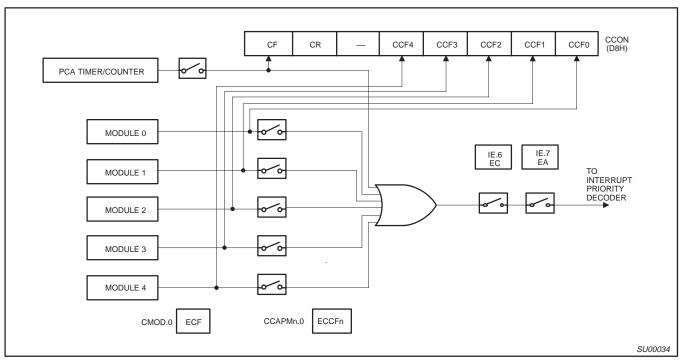


Figure 4. PCA Interrupt System

80C575/83C575/87C575

	CM	OD Addr	ess = OD9H	ł					R	eset Value = 00XX X000B
		CIDL	WDTE	_	-	-	CPS1	CPS0	ECF	
	Bit:	7	6	5	4	3	2	1	0	
Symbol	Funct	ion								
CIDL			ntrol: CIDL = during idle.	= 0 progran	ns the PCA	Counter to	continue fur	nctioning du	ring idle M	ode. CIDL = 1 programs
WDTE	Watch	dog Timer	r Enable: W	DTE = 0 di	sables Wat	chdog Time	er function or	n PCA Mod	ule 4. WDT	E = 1 enables it.
_			d, reserved							
CPS1	PCA (Count Puls	e Select bit	1.						
CPS0	PCA (CPS1		e Select bit Selecte	0. ed PCA In	put**					
	0	0	0	Intern	al clock, fog	sc ÷ 12				
	0	1	1	Intern	al clock, fog	sc ÷ 4				
	1	0	2	Timer	0 overflow					
	1	1	3	Extern	nal clock at	ECI/P1.2 p	in (max. rate	$e = f_{OSC} \div 8$)	
ECF		Enable Counction of C		ow interruj	ot: ECF = 1	enables CI	bit in CCO	N to genera	te an interr	rupt. ECF = 0 disables
	be 0, and it	s active value	reserved bits. T will be 1. The v	,		,		oke new feature	s. In that case	, the reset or inactive value of the
	nator neque									

Figure 5. CMOD: PCA Counter Mode Register

	Bit Ac	ddressable								_
		CF	CR	-	CCF4	CCF3	CCF2	CCF1	CCF0	
	Bit:	7	6	5	4	3	2	1	0	
Symbol	Fund	tion								
CF								. CF flags and by softward		if bit ECF in CMOD is
		,	,							
CR				it. Set by s				. Must be c	leared by s	oftware to turn the PCA
CR -	coun	Counter Ru ter off.			oftware to tu			. Must be c	leared by s	oftware to turn the PCA
_	coun Not ii	Counter Ru ter off. mplemente	un control b d, reserved	for future u	oftware to tu use*.	ırn the PCA	counter or		-	oftware to turn the PCA
– CCF4	coun Not ii PCA	Counter Ru ter off. mplementer Module 4 in	un control b d, reserved nterrupt flag	for future u J. Set by ha	oftware to tu use*. ardware whe	irn the PCA en a match o	counter or	occurs. Mus	t be cleared	
– CCF4 CCF3	coun Not ii PCA PCA	Counter Ru ter off. mplementer Module 4 in Module 3 in	un control b d, reserved nterrupt flag	for future u J. Set by ha J. Set by ha	oftware to tu use*. urdware whe urdware whe	rn the PCA en a match o en a match o	or capture c	occurs. Mus	t be cleared	d by software.
CCF4 CCF3 CCF2	coun Not ii PCA PCA PCA	Counter Ru ter off. mplemente Module 4 in Module 3 in Module 2 in	un control b d, reserved nterrupt flag nterrupt flag nterrupt flag	for future u J. Set by ha J. Set by ha J. Set by ha	oftware to tu use*. ardware whe ardware whe ardware whe	ern the PCA en a match o en a match o en a match o	or capture cor capture cor capture c	occurs. Mus occurs. Mus occurs. Mus	t be cleared t be cleared t be cleared	d by software. d by software.
CR - CCF4 CCF3 CCF2 CCF1 CCF0	coun Not in PCA PCA PCA PCA	Counter Ru ter off. mplemente Module 4 in Module 3 in Module 2 in Module 1 in	un control b d, reserved nterrupt flag nterrupt flag nterrupt flag nterrupt flag	for future u J. Set by ha J. Set by ha J. Set by ha J. Set by ha	oftware to tu use*. ardware whe ardware whe ardware whe ardware whe	en a match o en a match o en a match o en a match o en a match o	counter or or capture c or capture c or capture c or capture c	occurs. Mus occurs. Mus occurs. Mus occurs. Mus	t be cleared t be cleared t be cleared t be cleared	d by software. d by software. d by software.

Figure 6. CCON: PCA Counter Control Register

80C575/83C575/87C575

		CCAF CCAF CCAF CCAF	PM2 0DC PM3 0DC	CH DH						
	Not Bit	t Addressa	ıble							
		-	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn	
	Bit:	7	6	5	4	3	2	1	0	-
Symbol	Func	tion								
_	Not ir	nplemente	d, reserved	for future u	se*.					
ECOMn	Enab	le Compar	ator. ECOM	n = 1 enabl	es the com	parator fund	ction.			
CAPPn	Captu	ure Positiv	e, CAPPn =	1 enables p	positive edg	e capture.				
CAPNn	Captu	ure Negativ	ve, CAPNn =	= 1 enables	negative e	dge capture	Э.			
MATn			IATn = 1, a r set, flagging			ter with this	module's c	compare/ca	pture registe	er causes the CCFn bit
TOGn		e. When T toggle.	'OGn = 1, a	match of th	e PCA cour	nter with thi	s module's	compare/ca	apture regis	ter causes the CEXn
PWMn	Pulse	Width Mo	dulation Mo	de. PWMn	= 1 enables	the CEXn	pin to be us	sed as a pu	lse width me	odulated output.
ECCFn	Enab	le CCF inte	errupt. Enab	les compar	e/capture fl	ag CCFn in	the CCON	register to	generate ar	n interrupt.

*User software should not write 1s to reserved bits. These bits may be used in future 8051 family products to invoke new features. In that case, the reset or inactive value of the new bit will be 0, and its active value will be 1. The value read from a reserved bit is indeterminate. SU00037

Figure 7. CCAPMn: PCA Modules Compare/Capture Registers

-	ECOMn	CAPPn	CAPNn	MATn	TOGn	PWMn	ECCFn	MODULE FUNCTION
Х	0	0	0	0	0	0	0	No operation
Х	Х	1	0	0	0	0	Х	16-bit capture by a positive-edge trigger on CEXn
Х	Х	0	1	0	0	0	Х	16-bit capture by a negative trigger on CEXn
Х	Х	1	1	0	0	0	Х	16-bit capture by a transition on CEXn
Х	1	0	0	1	0	0	Х	16-bit Software Timer
Х	1	0	0	1	1	0	Х	16-bit High Speed Output
Х	1	0	0	0	0	1	0	8-bit PWM
Х	1	0	0	1	Х	0	Х	Watchdog Timer

Figure 8. PCA Module Modes (CCAPMn Register)

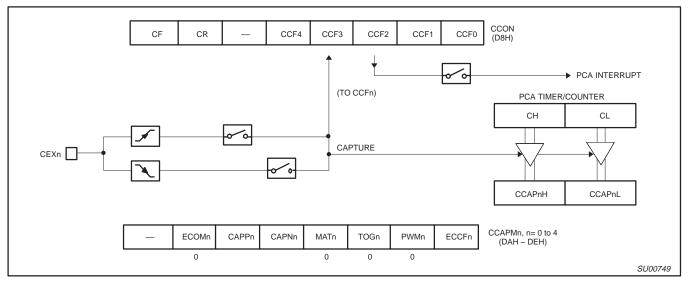


Figure 9. PCA Capture Mode

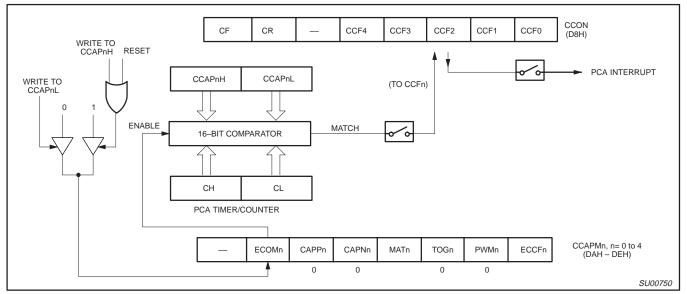


Figure 10. PCA Compare Mode

80C575/83C575/87C575

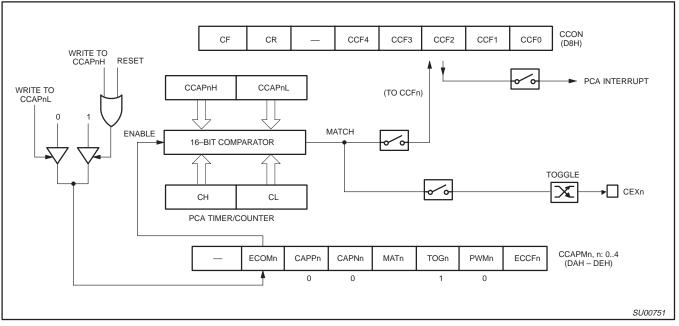


Figure 11. PCA High Speed Output Mode

Pulse Width Modulator Mode

All of the PCA modules can be used as PWM outputs. Figure 12 shows the PWM function. The frequency of the output depends on the source for the PCA timer. All of the modules will have the same frequency of output because they all share the PCA timer. The duty cycle of each module is independently variable using the module's capture register CCAPLn. When the value of the PCA CL SFR is less than the value in the module's CCAPLn SFR the output will be low, when it is equal to or greater than the output will be high. When CL overflows from FF to 00, CCAPLn is reloaded with the value in CCAPHn. the allows updating the PWM without glitches. The PWM and ECOM bits in the module's CCAPMn register must be set to enable the PWM mode.

WATCHDOG TIMER

The watchdog timer is not directly loadable by the user. Instead, the value to be loaded into the main timer is held in an autoload register or is part of the mask ROM programming. In order to cause the main timer to be loaded with the appropriate value, a special sequence of software action must take place. This operation is referred to as feeding the watchdog timer.

To feed the watchdog, two instructions must be sequentially executed successfully. No intervening instruction fetches are allowed, so interrupts should be disabled before feeding the watchdog. The instructions should move A5H to the WFEED1 register and then 5AH to the WFEED2 register. If WFEED1 is correctly loaded and WFEED2 is not correctly loaded, then an immediate underflow will occur.

The watchdog timer subsystem has two modes of operation. Its principal function is a watchdog timer. In this mode it protects the system from incorrect code execution by causing a system reset when the watchdog timer underflows as a result of a failure of software to feed the timer prior to the timer reaching its terminal count. If the user does not employ the watchdog function, the watchdog subsystem can be used as a timer. In this mode, reaching the terminal count sets a flag. In most other respects, the timer mode possesses the characteristics of the watchdog mode. This is done to protect the integrity of the watchdog function.

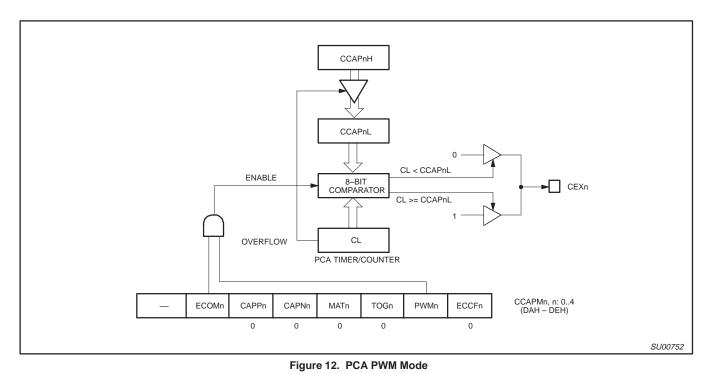
The watchdog timer subsystem consists of a prescaler and a main counter. The prescaler has 8 selectable taps off the final stages and the output of a selected tap provides the clock to the main counter. The main counter is the section that is loaded as a result of the software feeding the watchdog and it is the section that causes the system reset

(watchdog mode) or time-out flag to be set (timer mode) if allowed to reach its terminal count.

Programming the Watchdog Timer

Both the EPROM and ROM devices have a set of SFRs for holding the watchdog autoload values and the control bits. The watchdog time-out flag is present in the watchdog control register and operates the same in all versions. In the EPROM device, the watchdog parameters (autoload value and control) are always taken from the SFRs. In the ROM device, the watchdog parameters can be mask programmed or taken from the SFRs. The selection to take the watchdog parameters from the SFRs or from the mask programmed values is controlled by EA (external access). When EA is high (internal ROM access), the watchdog parameters are taken from the mask programmed values. If the watchdog is mask programmed to the timer mode, then the autoload values and the pre-scaler taps are taken from the SFRs. When EA is low (external access), the watchdog parameters are taken from the SFRs. The user should be able to leave code in his program which initializes the watchdog SFRs even though he has migrated to the mask ROM part. This allows no code changes from EPROM prototyping to ROM coded production parts.

80C575/83C575/87C575



Watchdog Detailed Operation

EPROM Device (and ROMless Operation: EA = 0)

In the ROMless operation (ROM part, $\overline{EA} = 0$) and in the EPROM device, the watchdog operates in the following manner (see Figure 14).

Whether the watchdog is in the watchdog or timer mode, when external RESET is applied, the following takes place:

- Watchdog mode bit set to watchdog mode.
- Watchdog run control bit set to ON.
- Autoload register set to 00 (min. count).
- Watchdog time-out flag cleared.
- Prescaler is cleared.
- Prescaler tap set to the highest divide.
- Autoload takes place.

The watchdog can be fed even though it is in the timer mode.

Note that the operational concept is for the watchdog mode of operation, when coming out of a hardware reset, the software should load the autoload registers, set the mode to watchdog, and then feed the watchdog (cause an autoload). The watchdog will now be starting at a known point.

If the watchdog is in the watchdog mode and running and happens to underflow at the time

ovtornal RESET is applied the watch

the external RESET is applied, the watchdog time-out flag will be cleared.

When the watchdog is in the watchdog mode and the watchdog underflows, the following action takes place (see Figure 16):

- Autoload takes place.
- Watchdog time-out flag is set
- Mode bit unchanged.
- Watchdog run bit unchanged.
- Autoload register unchanged.
- Prescaler tap unchanged.
- All other device action same as external reset.

Note that if the watchdog underflows, the program counter will start from 00H as in the case of an external reset. The watchdog time-out flag can be examined to determine if the watchdog has caused the reset condition. The watchdog time-out flag bit can be cleared by software.

When the watchdog is in the timer mode and the timer software underflows, the following action takes place:

- Autoload takes place.
- Watchdog time-out flag is set
- Mode bit unchanged.
- Watchdog run bit unchanged.

- Autoload register unchanged.
- Prescaler tap unchanged.

Mask ROM Device (EA = 1)

In the mask ROM device, the watchdog mode bit (WDMOD) is mask programmed and the bit in the watchdog command register is read only and reflects the mask programmed selection. If the mask programmed mode bit selects the timer mode, then the watchdog run bit (WDRUN) operates as described under EPROM Device. If the mask programmed bit selects the watchdog mode, then the watchdog run bit has no effect on the timer operation (see Figure 15).

Watchdog Function

The watchdog consists of a programmable prescaler and the main timer. The prescaler derives its clock from the on-chip oscillator. The prescaler consists of a divide by 12 followed by a 13 stage counter with taps from stage 6 through stage 13. This is shown in Figure 17. The tap selection is programmable. The watchdog main counter is a down counter clocked (decremented) each time the programmable prescaler underflows. The watchdog generates an underflow signal (and is autoloaded) when the watchdog is at count 0 and the clock to decrement the watchdog occurs. The watchdog is 8 bits long and the autoload value can range from 0 to FFH. (The

Product specification

CMOS single-chip 8-bit microcontrollers

autoload value of 0 is permissible since the prescaler is cleared upon autoload).

This leads to the following user design equations. Definitions :t_{OSC} is the oscillator period, N is the selected prescaler tap value, W is the main counter autoload value, t_{MIN} is the minimum watchdog time-out value (when the autoload value is 0), t_{MAX} is the maximum time-out value (when the autoload value is FFH), t_D is the design time-out value.

 $t_{MIN} = t_{OSC} \times 12 \times 64$

 $t_{MAX} = t_{MIN} \times 128 \times 256$

 $t_D = t_{MIN} \times 2^{PRESCALER} \times (W + 1)$ (where prescaler = 0, 1, 2, 3, 4, 5, 6, or 7)

Note that the design procedure is anticipated to be as follows. A t_{MAX} will be chosen either from equipment or operation considerations and will most likely be the next convenient value higher than t_D . (If the watchdog were inadvertently to start from FFH, an overflow would be guaranteed, barring other anomalies, to occur within t_{MAX}). Then the value for the prescaler would be chosen from:

prescaler = log2 (t_{MAX} / (t_{OSC} × 12 × 256)) - 6

This then also fixes t_{MIN} . An autoload value would then be chosen from:

 $W = t_D / t_{MIN} - 1$

The software must be written so that a feed operation takes place every t_D seconds from the last feed operation. Some tradeoffs may need to be made. It is not advisable to include feed operations in minor loops or in subroutines unless the feed operation is a specific subroutine.

Watchdog Control Register (WDCON) (Bit Addressable) Address C0

The following bits of this register are read only in the ROM part when \overline{EA} is high: WDMOD, PRE0, PRE1, and PRE2. That is, the register will reflect the mask programmed values. In the ROM part with \overline{EA} high, these bits are taken from mask coded bits and are not readable by the program. WDRUN is read only in the ROM part when \overline{EA} is high and WDMOD is in the watchdog mode. When WDMOD is in the timer mode, WDRUN functions normally.

The parameters written into WDMOD, PRE0, PRE1, and PRE2 by the program are not applied directly to the watchdog timer subsystem. The watchdog timer subsystem is directly controlled by a second register which stores these bits. The transfer of these bits from the user register (WDMOD) to the second control register takes place when the watchdog is fed. This prevents random code execution from directly foiling the watchdog function. This does not affect the operation where these bits are taken from mask coded values.

The reset values of the WDCON and WDL registers will be such that the timer resets to the watchdog mode with a timeout period of $12 \times 64 \times 128 \times t_{OSC}$. The watchdog timer will not generate an interrupt. Additional bits in WDCON are used to disable reset generation by the oscillator fail and low voltage detect circuits. WDCON can be written by software only by executing a valid watchdog feed sequence.

WDCON Register Bit Definitions

giotoi Dit E	
PRE2	Prescaler Select 2,
	reset to 1
PRE1	Prescaler Select 1,
	reset to 1
PRE0	Prescaler Select 0,
	reset to 1
LVRE	Low Voltage Reset
	Enable, reset to 1
	(enabled)
OFRE	Oscillator Fail Reset
	Enable, reset to 1
	(enabled)
WDRUN	Watchdog Run,
	reset to 1 (enabled)
WDTOF	Watchdog Timeout
	Flag, reset =
	Indeterminate
WDMOD	Watchdog Mode,
	reset to 1 (watchdog
	mode)
	PRE1 PRE0 LVRE OFRE WDRUN WDTOF

Enhanced UART

The UART operates in all of the usual modes that are described in the first section of this book for the 80C51. In addition the UART can perform framing error detect by looking for missing stop bits, and automatic address recognition. The 87C575 UART also fully supports multiprocessor communication as does the standard 80C51 UART.

80C575/83C575/87C575

When used for framing error detect the UART looks for missing stop bits in the communication. A missing bit will set the FE bit in the SCON register. The FE bit shares the SCON.7 bit with SM0 and the function of SCON.7 is determined by PCON.6 (SMOD0) (see Figure 19). If SMOD0 is set then SCON.7 functions as FE. SCON.7 functions as SM0 when SMOD0 is cleared. When used as FE SCON.7 can only be cleared by software. Refer to Figure 18.

Automatic Address Recognition

Automatic Address Recognition is a feature which allows the UART to recognize certain addresses in the serial bit stream by using hardware to make the comparisons. This feature saves a great deal of software overhead by eliminating the need for the software to examine every serial address which passes by the serial port. This feature is enabled by setting the SM2 bit in SCON. In the 9 bit UART modes, mode 2 and mode 3, the Receive Interrupt flag (RI) will be automatically set when the received byte contains either the "Given" address or the "Broadcast" address. The 9 bit mode requires that the 9th information bit is a 1 to indicate that the received information is an address and not data. Automatic address recognition is shown in Figure 20.

The 8 bit mode is called Mode 1. In this mode the RI flag will be set if SM2 is enabled and the information received has a valid stop bit following the 8 address bits and the information is either a Given or Broadcast address.

Mode 0 is the Shift Register mode and SM2 is ignored.

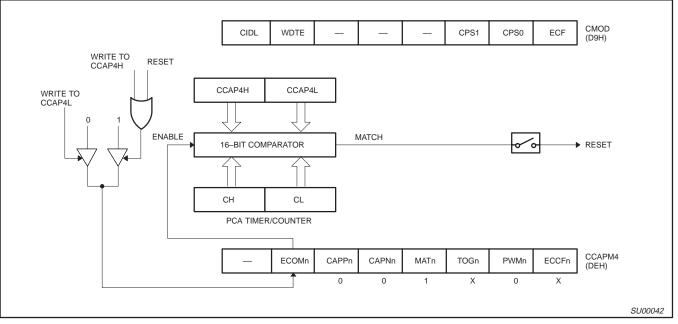


Figure 13. PCA Watchdog Timer

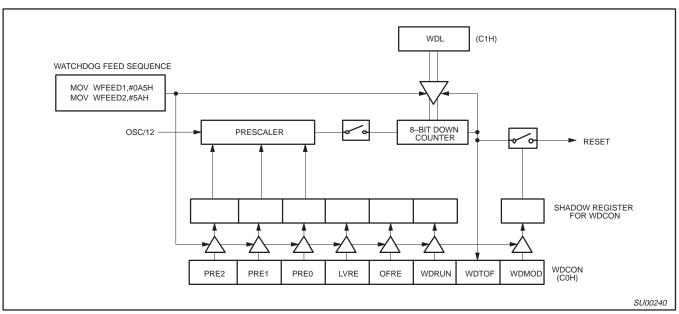


Figure 14. Watchdog Timer in 87C575 and 80C575 / 83C575 (EA = 0)

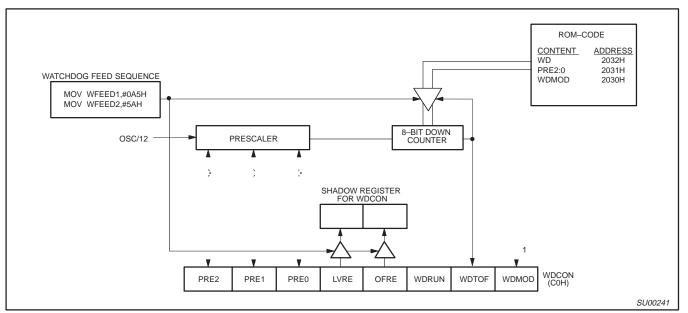
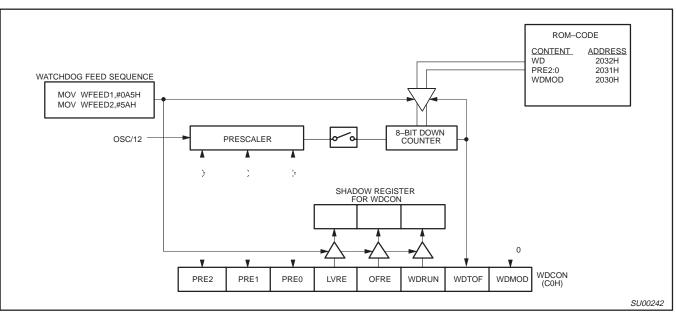


Figure 15. Watchdog Timer of 83C575 in Watchdog Mode (EA = 1, WDMOD = 1)





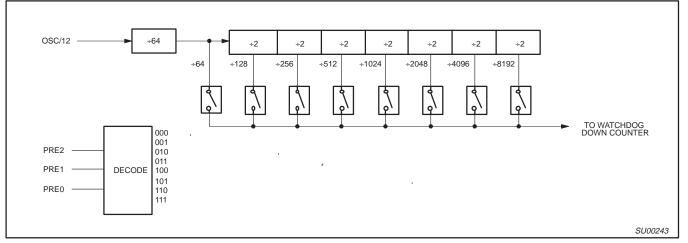


Figure 17. Watchdog Prescaler

		SCON Add	ress = 98H						F	Reset Value = 0000 0000B
	Bit Ac	dressable								_
		SM0/FE	SM1	SM2	REN	TB8	RB8	ті	RI	
	Bit:	7	6	5	4	3	2	1	0	
		(SMOD0 = 0)	0/1)*							
Symbol	Fun	ction								
FE		ning Error bi les but shou								t is not cleared by valid e FE bit.
SM0	Seri	al Port Mode	Bit 0, (SM	OD0 must	= 0 to acce	ess bit SM0)				
SM1		al Port Mode								
	SMO) SM1	Mode	Descr	iption	Baud Rate	**			
	0	0	0		egister	f _{OSC} /12				
	0	1	1	8-bit L		variable	(22			
	1	0	2 3	9-bit L 9-bit L		f _{OSC} /64 or t variable	OSC/32			
SM2	rece In M	ived 9th data	a bit (RB8) 2 = 1 then	is 1, indica RI will not b	ting an add	lress, and th d unless a va	e received	byte is a Gi	ven or Bro	ot be set unless the adcast Address. e received byte is a
REN	Ena	bles serial re	ception. Se	et by softwa	are to enab	le reception.	Clear by s	oftware to d	lisable rec	eption.
TB8	The	9th data bit	that will be	transmitted	l in Modes	2 and 3. Set	or clear by	software a	s desired.	
RB8		odes 2 and 3 ode 0, RB8			was receiv	ved. In Mode	1, if SM2 =	= 0, RB8 is t	he stop bi	t that was received.
ГІ		nsmit interrup er modes, in a						lode 0, or a	t the begir	nning of the stop bit in the
RI		eive interrup other modes								ough the stop bit time in
FE: IOD0 is locate	ed at PCO r frequenc									

Figure 18. SCON: Serial Port Control Register

80C575/83C575/87C575

CMOS single-chip 8-bit microcontrollers

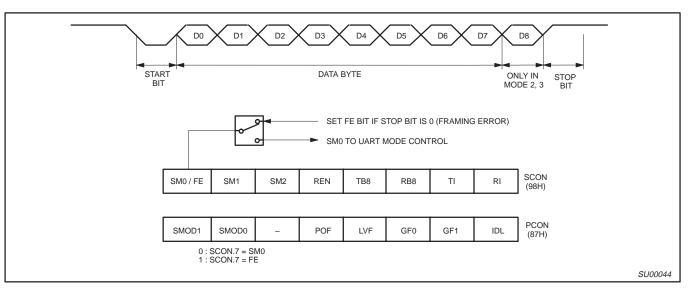


Figure 19. UART Framing Error Detection

Using the Automatic Address Recognition feature allows a master to selectively communicate with one or more slaves by invoking the Given slave address or addresses. All of the slaves may be contacted by using the Broadcast address. Two special Function Registers are used to define the slave's address, SADDR, and the address mask, SADEN. SADEN is used to define which bits in the SADDR are to b used and which bits are "don't care". The SADEN mask can be logically ANDed with the SADDR to create the "Given" address which the master will use for addressing each of the slaves. Use of the Given address allows multiple slaves to be recognized while excluding others. The following examples will help to show the versatility of this scheme:

Slave 0	SADDR	=	1100	0000
	SADEN	=	<u>1111</u>	1101
	Given	=	1100	00X0
Slave 1	SADDR	=	1100	0000
	SADEN	=	<u>1111</u>	1110
	Given	=	1100	000X

In the above example SADDR is the same and the SADEN data is used to differentiate between the two slaves. Slave 0 requires a 0 in bit 0 and it ignores bit 1. Slave 1 requires a 0 in bit 1 and bit 0 is ignored. A unique address for Slave 0 would be 1100 0010 since slave 1 requires a 0 in bit 1. A unique address for slave 1 would be 1100 0001 since a 1 in bit 0 will exclude slave 0. Both slaves can be selected at the same time by an address which has bit 0 = 0 (for slave 0) and bit 1 = 0 (for slave 1). Thus, both could be addressed with 1100 0000.

In a more complex system the following could be used to select slaves 1 and 2 while excluding slave 0:

Slave 0	SADDR	=	1100	0000
	SADEN	=	<u>1111</u>	<u>1001</u>
	Given	=	1100	0XX0
Slave 1	SADDR	=	1110	0000
	SADEN	=	<u>1111</u>	<u>1010</u>
	Given	=	1110	0X0X
Slave 2	SADDR	=	1110	0000
	SADEN	=	<u>1111</u>	<u>1100</u>
	Given	=	1110	00XX

In the above example the differentiation among the 3 slaves is in the lower 3 address bits. Slave 0 requires that bit 0 = 0 and it can be uniquely addressed by 1110 0110. Slave 1 requires that bit 1 = 0 and it can be uniquely addressed by 1110 and 0101. Slave 2 requires that bit 2 = 0 and its unique address is 1110 0011. To select Slaves 0 and 1 and exclude Slave 2 use address 1110 0100, since it is necessary t make bit 2 = 1 to exclude slave 2.

The Broadcast Address for each slave is created by taking the logical OR of SADDR and SADEN. Zeros in this result are treated

as don't-cares. In most cases, interpreting the don't-cares as ones, the broadcast address will be FF hexadecimal.

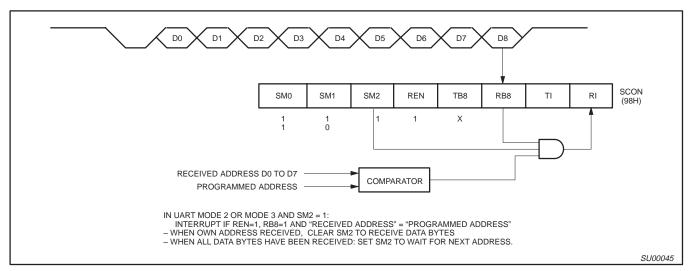
Upon reset SADDR (SFR address 0A9H) and SADEN (SFR address 0B9H) are loaded with 0s. This produces a given address of all "don't cares" as well as a Broadcast address of all "don't cares". this effectively disables the Automatic Addressing mode and allows the microcontroller to use standard 80C51 type UART drivers which do not make use of this feature.

Analog Comparators

Four analog comparators are provided on chip. Three comparators have a common negative reference CMPR- and independent positive inputs CMP1+, CMP2+, CMP3+ on port 3. The fourth comparator has independent positive and negative inputs CMP0+ and CMP0- on port 1. The CMP register contains an output and enable bit for each comparator. The CMP register is bit addressable and is located at SFR address E8H. Figure 21 shows the connection of the comparators.

Pullups at the comparator input pins will be disabled by hardware when the comparator is enabled. In addition, to make inputs high impedance, the corresponding port SFR bits must be set by software to disable the pulldowns.

80C575/83C575/87C575





CMP Register Bit Definitions

CMP.7	enable comparator 3,
	disable pullups at P3.4, P3.7
CMP.6	enable comparator 2,
	disable pullups at P3.4, P3.6
CMP.5	enable comparator 1,
	disable pullups at P3.4, P3.5
CMP.4	enable comparator 0,
	disable pullups at P1.0, P1.1
CMP.3	comparator 3 output (read only)
CMP.2	comparator 2 output (read only)
CMP.1	comparator 1 output (read only)
CMP.0	comparator 0 output (read only)

All comparators are disabled automatically in power down mode, in idle mode unused comparators should be disabled by software to save power. A comparator can generate an interrupt that will terminate idle mode.

The CMPE register contains bits to enable each comparator to drive external output pins or internal PCA capture inputs. Pullups at the output pins are disabled by hardware when the external comparator output is enabled. The comparator output is wire-ORed with the corresponding port SFR bit, so the SFR bit must also be set by software to enable the output.

CMPE Register Bit Definitions

- CMPE.7 enables comparator 3 to drive CEX3
- CMPE.6 enables comparator 2 to drive CEX2
- CMPE.5 enables comparator 1 to drive CEX1
- CMPE.4 enables comparator 0 to drive CEX0
- CMPE.3 enables comparator 3 output on P1.6 (open drain)
- CMPE.2 enables comparator 2 output on P1.5 (open drain)
- CMPE.1 enables comparator 1 output on P1.4 (open drain)
- CMPE.0 enables comparator 0 output on P1.3 (open drain)

When 1s are written to CMPE bits 7-4, the comparator outputs will drive the corresponding capture input. (This function is not available in the idle or power-down mode.) When 1s are written to CMPE bits 3-0 the comparator output will also drive the corresponding port 1 pin. (This function is available in idle mode.) If the comparator's enabled to drive the capture input but not the port pin, then the port pin can be used for general purpose I/O. When a comparator output is enabled, pullups at the output pin are disabled and the output becomes open drain. The comparator output can be used to trigger a capture input in idle mode by programming the CMPE register to drive the

pin from the comparator output to have the pin supply the capture trigger.

There are two special function registers associated with the comparators. They are CMP which contains the comparator enables and a bit that can be read by software to determine the state of each comparator's output, and CMPE which controls whether the output from each comparator drives the associated output pin or a capture input associated with one of the PCA modules.

The CMP registers bits 0–3 can be read by software to determine the state of the output of each comparator. To do this the associated comparator must be enabled but the output in port 1 can be disabled. This allows easy polling of the comparator output value without the need to use up a port pin.

The CMPE register allows the comparator to drive the associated PCA module capture input, so that on compare a capture can be generated in the PCA. Bits 0–3 of this register enable the comparator output to drive the associated port 1 output circuitry. Used as a comparator output this circuitry is open drain. To enable the comparator output to drive to port 1, the corresponding port bit must also be set to disable the pulldown. If the comparator is not enabled to drive the port 1 circuitry, the associated port 1 pin can be used for other I/O. This includes when a comparator is enabled to drive the capture input to a PCA module.

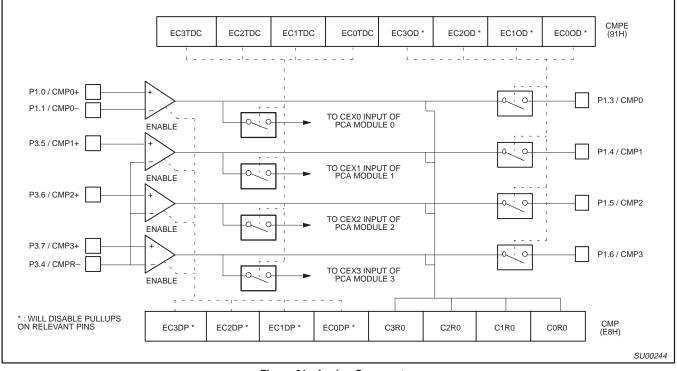
Reduced EMI Mode

There are two bits in the AUXR register that can be set to reduce the internal clock drive and disable the ALE output. AO (AUXR.0)

when set turns off the ALE output. LO (AUXR.1) when set reduces the drive of the internal clock circuitry. Both bits are cleared

on Reset. With LO set the 87C575 will still operate at 12MHz, but will have reduced EMI in the range above 100MHz.

80C575/83C575/87C575



AUXR (8EH)

			—	—		LO	AO
AO:	٦	Turns	off Al	_E ou	tput.		
LO:	C		ry. 8X				ock 12MH

INTERNAL RESET

Internal resets generated by the power on, low voltage, and oscillator fail detect circuits are self timed to guarantee proper initialization of the 8XC575. Reset will be held approximately 24 oscillator periods after normal conditions are detected by all enabled detect circuits. Internal resets do not drive RST but will cause missing pulses on ALE.

Interrupt Enable (IE) Register

EA	IE.7	enable all interrupts
EC	IE.6	enable PCA interrupt
ET2	IE.5	enable Timer 2 interrupt
ES	IE.4	enable Serial I/O interrupt
ET1	IE.3	enable Timer 1 interrupt
EX1	IE.2	enable External interrupt 1
ET0	IE.1	enable Timer 0 interrupt
EX0	IE.0	enable External interrupt 0

Figure 21. Analog Comparators

Interrupt Priority (IP) Register						
	IP.7	reserved				
PPC	IP.6	PCA interrupt priority				
PT2	IP.5	Timer 2 interrupt priority				
PS	IP.4	Serial I/O interrupt priority				
PT1	IP.3	Timer 1 interrupt priority				
PX1	IP.2	External interrupt 1 priority				
PT0	IP.1	Timer 0 interrupt priority				
PX0	IP.0	External interrupt 0 priority				

Priority 1 2 3 4	Source INTO Timer 0 INT1 Timer 1	Flag IE0 TF0 IE1 TF1	Vector 03H highest priority 0BH 13H 1BH			
87C575						
5	PCA	CF,CCFn	33H			
6	Serial I/O	RI,TI	23H			
7	Timer 2	TF2/EXF2	2BH lowest priority			
80C575	/83C575/87	C575				
5	Serial I/O	RI/TI	23H			
6	Timer 2	TF2/EXF2	23H			
7	PCA	CF,CCF_n	33H lowest priority			
Power Control (PCON) Register						
SMOD		• •	le baud rate bit			
SMOD	0 PCON	N.6 SCO	N.7 access control			
OSF	PCON	V.5 oscill	ator fail flag			
POF	PCON	V.4 powe	er off flag			

POF	PCON.4	power off flag
LVF	PCON.3	low voltage flag
GF0	PCON.2	general purpose flag
PD	PCON.1	power down mode bit
IDL	PCON.0	idle mode bit
	ullun Diach	la Dagistar

Port 2 Pullup Disable Register

80C575/83C575/87C575

OSCILLATOR CHARACTERISTICS

XTAL1 and XTAL2 are the input and output, respectively, of an inverting amplifier. The pins can be configured for use as an on-chip oscillator, as shown in the Logic Symbol, page 1085.

To drive the device from an external clock source, XTAL1 should be driven while XTAL2 is left unconnected. There are no requirements on the duty cycle of the external clock signal, because the input to the internal clock circuitry is through a divide-by-two flip-flop. However, minimum and maximum high and low times specified in the data sheet must be observed.

IDLE MODE

In idle mode, the CPU puts itself to sleep while all of the on-chip peripherals stay active. The instruction to invoke the idle mode is the last instruction executed in the normal operating mode before the idle mode is activated. The CPU contents, the on-chip RAM, and all of the special function registers remain intact during this mode. The idle mode can be terminated either by any enabled interrupt (at which time the process is picked up at the interrupt service routine and continued), or by a hardware reset which starts the processor in the same manner as a power-on reset.

POWER-DOWN MODE

In the power-down mode, the oscillator is stopped and the instruction to invoke power-down is the last instruction executed. Only the contents of the on-chip RAM are preserved. The control bits for the reduced power modes are in the special function register PCON. Power-down mode can be terminated with either a hardware reset or external interrupt. With an external interrupt INTO or INT1 must be enabled and configured as level sensitive. Holding the pin low restarts to oscillator and bringing the pin back high completes the exit.

If the watchdog is enabled (WDRUN = 1), then power-down mode is disabled.

DESIGN CONSIDERATIONS

At power-on, the voltage on V_{CC} must come up with \overline{RST} low for a proper start-up.

Table 2 shows the state of I/O ports during low current operating modes.

Table 2. External Pin Status During Idle and Power-Down Modes	j.
---	----

MODE	PROGRAM MEMORY	ALE	PSEN	PORT 0	PORT 1	PORT 2	PORT 3
Idle	Internal	1	1	Data	Data	Data	Data
Idle	External	1	1	Float	Data	Address	Data
Power-down	Internal	0	0	Data	Data	Data	Data
Power-down	External	0	0	Float	Data	Data	Data

80C575/83C575/87C575

ROM CODE SUBMISSION

When submitting ROM code for the 83C575, the following must be specified:

- 1. 8k byte user ROM data
- 2. 32 byte ROM encryption key
- 3. ROM security bits
- 4. The watchdog timer parameters.

ADDRESS	CONTENT	BIT(S)	COMMENT
0000H to 1FFFH	DATA	7:0	User ROM Data
2000H to 201FH	KEY	7:0	ROM Encryption Key FFH = no encryption
2020H	Reserved Security Bit 2 Security Bit 1	2 1 0	Must = 1 0 = enable, 1 = disable 0 = enable, 1 = disable
2030H	Reserved	7:0	Must = FFH
2031H	Reserved	7:0	Must = FFH
2032H	WDL ¹	7:0	Watchdog reload value (see specification)
2033H	WDCON ¹	7:5	PRE2:0
2033H	WDCON ¹	4	LVRE
2033H	WDCON ¹	3	OFRE
2033H	WDCON ¹	2	WDRUN=0, not ROM coded
2033H	WDCON ¹	1	WDTOF=0, not ROM coded
2033H	WDCON ¹	0	WDMOD

NOTES:

1. See Watchdog Timer Specification for definition of WDL and WDCON bits.

Security Bit 1: When programmed, this bit has two effects on masked ROM parts:

1. External MOVC is disabled, and

2. EA# is latched on Reset.

Security Bit 2: When programmed, this bit inhibits Verify User ROM.

ABSOLUTE MAXIMUM RATINGS^{1, 2, 3}

PARAMETER	RATING	UNIT
Operating temperature under bias	-55 to +125	°C
Storage temperature range	-65 to +150	°C
Voltage on \overline{EA}/V_{PP} pin to V_{SS}	0 to +13.0	V
Voltage on any other pin to V_{SS}	-0.5 to +6.5	V
Maximum I _{OL} per I/O pin	15	mA
Power dissipation (based on package heat transfer limitations, not device power consumption)	1.5	W

NOTES:

 Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any conditions other than those described in the AC and DC Electrical Characteristics section of this specification is not implied.

2. This product includes circuitry specifically designed for the protection of its internal devices from the damaging effects of excessive static charge. Nonetheless, it is suggested that conventional precautions be taken to avoid applying greater than the rated maxima.

3. Parameters are valid over operating temperature range unless otherwise specified. All voltages are with respect to V_{SS} unless otherwise noted.

DC ELECTRICAL CHARACTERISTICS

 T_{amb} = 0°C to +70°C and –40°C to +125°C, V_{CC} = 5V ±10%, V_{SS} = 0V

		TEST		LIMITS			
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP ¹	MAX	UNIT	
V _{IL}	Input low voltage (Ports 0, 2, 3, except 3.2, 3.3)		-0.5		0.5V _{CC} -0.6	V	
V _{IL1}	Input low voltage (Ports 1, 3.2, 3.3, XTAL1, RST)		-0.5		0.2V _{CC} -0.5	V	
V _{IL2}	Input low voltage (EA)		0		0.2V _{CC} -0.45	V	
V _{IH}	Input high voltage (Ports 0, 2, 3, except 3.2, 3.3)		0.5V _{CC} +0.8		V _{CC} +0.5	V	
V _{IH1}	Input high voltage (Ports 1, 3.2, 3.3)		0.8V _{CC} +0.3		V _{CC} +0.5	V	
V _{IH2}	Input high voltage (EA)		0.2V _{CC} +0.9		V _{CC} +0.5	V	
V _{IH3}	Input high voltage (XTAL1, RST)		0.7V _{CC}		V _{CC} +0.5	V	
HYS	Hysteresis (Ports 0, 2, 3, except 3.2, 3.3)		200			mV	
HYS1	Hysteresis (Ports 1, 3.2, 3.3)		50			mV	
V _{OL}	Output voltage low (Ports 1, 2, 3, except 3.1)	I _{OL} = 1.6mA			0.45	V	
V _{OL1}	Output voltage low (Ports 0, ALE, PSEN)	I _{OL} = 3.2mA			0.45	V	
V _{OL2}	Output voltage low P3.1 with bit cleared P3.1 with bit set	I _{OL} = 10.0mA I _{OL} = 1.6mA			0.50 0.45	V V	
V _{OH}	Output voltage high (Ports 1, 2, 3, except P3.1)	I _{OH} = −30μA	V _{CC} -0.7			V	
V _{OH1}	Output voltage high (Port 0 in external bus mode, ALE, PSEN)	I _{OH} = -3.2mA	V _{CC} -0.7			V	
V _{OH2}	Output voltage high P3.1 with bit cleared P3.1 with bit set	I _{OH} = -10.0mA I _{OH} = -1.6mA	V _{CC} -1.5 V _{CC} -1.5			V V	
V _{IO}	Offset voltage comparator inputs		-35		+35	mV	
V _{CR}	Common mode range comparator inputs		0		V _{CC}	V	
IIL	Logical 0 input current (Ports 1, 2, 3, except 3.1)	V _{IN} = 0.45V			-75	μA	
ITL	Logical 1-to-0 transition current (Ports 2, 3, except 3.1, 3.2, 3.3) ⁴	See Note 4			-600	μA	
TL1	Logical 1-to-0 transition current (Ports 1, 3.2, 3.3)	See Note 4			-450	μΑ	
L1	Input leakage current (Port 0, Port2 in open drain mode) ⁹	0.45 < V _{IN} < V _{CC}	2		40	μΑ	
L2	Input leakage current (EA, P3.1)	$0.45 < V_{IN} < V_{CC}$	-10		+10	μΑ	
LC	Input leakage current comparator inputs	$0 < V_{IN} < V_{CC}$	-1.0		+1.0	μΑ	
сс	Power supply current: ⁷ Active mode @ 16MHz ⁵ Idle mode @ 16MHz Power-down mode	See note 6		20 8 5	30 12 75	mA mA μA	
R _{RST}	Internal reset pull-up resistor	$V_{IN} = 0V$	50		200	kΩ	
√ _{LOW}	Low V _{CC} detect voltage		4.0		4.45	V	
C _{IO}	Pin capacitance ¹⁰	f = 1MHz			10	pF	

NOTES: (SEE NEXT PAGE)

80C575/83C575/87C575

NOTES TO THE DC ELECTRICAL CHARACTERISTICS TABLE:

- Typical ratings are not guaranteed. The values listed are at room temperature, 5V. 1.
- Capacitive loading on ports 0 and 2 may cause spurious noise to be superimposed on the Vols of ALE and ports 1 and 3. The noise is due 2. to external bus capacitance discharging into the port 0 and port 2 pins when these pins make 1-to-0 transitions during bus operations. In the worst cases (capacitive loading > 100pF), the noise pulse on the ALE pin may exceed 0.8V. In such cases, it may be desirable to qualify ALE with a Schmitt Trigger, or use an address latch with a Schmitt Trigger STROBE input. IoL can exceed these conditions provided that no single output sinks more than 5mA and no more than two outputs exceed the test conditions.
- Capacitive loading on ports 0 and 2 may cause the VOH on ALE and PSEN to momentarily fall below the 0.9V_{CC} specification when the 3. address bits are stabilizing.
- Pins of ports 1, 2 and 3 source a transition current when they are being externally driven from 1 to 0. The transition current reaches its 4. maximum value when VIN is between VIH and VIL.
- I_{CC}MAX at other frequencies can be determined from Figure 29. 5.
- See Figures 30 through 33 for I_{CC} test conditions. 6.
- Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF. 7.
- 8. Under steady state (non-transient) conditions, IOL must be externally limited as follows:
 - Maximum IOL per port pin: 10mA 26mA
 - Maximum I_{OL} per 8-bit port: Maximum total I_{OL} for all outputs: 71mA

If I_{OL} exceeds the test condition, V_{OL} may exceed the related specification. Pins are not guaranteed to sink current greater than the listed test conditions.

- 9. Specification applies to Port 2 when P2OD bit is set.
- 10.15pF MAX for the EA/VPP and P0.0 pins.

80C575/83C575/87C575

AC ELECTRICAL CHARACTERISTICS

 T_{amb} = 0°C to +70°C and –40°C to +125°C, V_{CC} = 5V ±10%, V_{SS} = 0V^1, 2

			VARIABL	E CLOCK	
SYMBOL	FIGURE	PARAMETER	MIN	MAX	
1/t _{CLCL}	22	Oscillator frequency: Speed Versions 8XC575 E	6	16	MHz
OSCF		Oscillator fail detect frequency	0.6	5.5	MHz
TR		Comparator response time		10	μs
t _{LHLL}	22	ALE pulse width	2t _{CLCL} -40		ns
t _{AVLL}	22	Address valid to ALE low	t _{CLCL} -25		ns
t _{LLAX}	22	Address hold after ALE low	t _{CLCL} -25		ns
t _{LLIV}	22	ALE low to valid instruction in		4t _{CLCL} -75	ns
t _{LLPL}	22	ALE low to PSEN low	t _{CLCL} -25		ns
t _{PLPH}	22	PSEN pulse width	3t _{CLCL} -45		ns
t _{PLIV}	22	PSEN low to valid instruction in		3t _{CLCL} -70	ns
t _{PXIX}	22	Input instruction hold after PSEN	0		ns
t _{PXIZ}	22	Input instruction float after PSEN		t _{CLCL} -25	ns
t _{AVIV}	22	Address to valid instruction in		5t _{CLCL} -85	ns
t _{PLAZ}	22	PSEN low to address float		10	ns
Data Memo	ory			_	
t _{RLRH}	23, 24	RD pulse width	6t _{CLCL} -100		ns
t _{WLWH}	23, 24	WR pulse width	6t _{CLCL} -100		ns
t _{RLDV}	23, 24	RD low to valid data in		5t _{CLCL} -110	ns
t _{RHDX}	23, 24	Data hold after RD	0		ns
t _{RHDZ}	23, 24	Data float after RD		2t _{CLCL} -28	ns
t _{LLDV}	23, 24	ALE low to valid data in		8t _{CLCL} -150	ns
t _{AVDV}	23, 24	Address to valid data in		9t _{CLCL} -165	ns
t _{LLWL}	23, 24	ALE low to RD or WR low	3t _{CLCL} -50	3t _{CLCL} +50	ns
t _{AVWL}	23, 24	Address valid to WR low or RD low	4t _{CLCL} -75		ns
t _{QVWX}	23, 24	Data valid to WR transition	t _{CLCL} -30		ns
t _{WHQX}	23, 24	Data hold after WR	t _{CLCL} -25		ns
t _{RLAZ}	23, 24	RD low to address float		0	ns
t _{WHLH}	23, 24	RD or WR high to ALE high	t _{CLCL} -25	t _{CLCL} +25	ns
External C	lock	_			
t _{CHCX}	26	High time	12		ns
t _{CLCX}	26	Low time	12		ns
t _{CLCH}	26	Rise time		20	ns
t _{CHCL}	26	Fall time		20	ns
Shift Regis	ter				
t _{XLXL}	25	Serial port clock cycle time	12t _{CLCL}		ns
t _{QVXH}	25	Output data setup to clock rising edge	10t _{CLCL} -133		ns
t _{XHQX}	25	Output data hold after clock rising edge	2t _{CLCL} -60		ns
t _{XHDX}	25	Input data hold after clock rising edge	0		ns
t _{XHDV}	25	Clock rising edge to input data valid		10t _{CLCL} -133	ns

NOTES:

 Parameters are valid over operating temperature range unless otherwise specified.
 Load capacitance for port 0, ALE, and PSEN = 100pF, load capacitance for all other outputs = 80pF.
 Interfacing the 80C32/52 to devices with float times up to 45ns is permitted. This limited bus contention will not cause damage to Port 0 drivers.

P - PSEN

t - Time

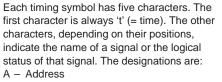
V - Valid

Q - Output data

R - RD signal

W- WR signal

EXPLANATION OF THE AC SYMBOLS

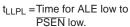


- C Clock
- D Input data
- H Logic level high
- I Instruction (program memory contents)
- L Logic level low, or ALE

Z - Float Examples: t_{AVLL} = Time for address valid to

X - No longer a valid logic level





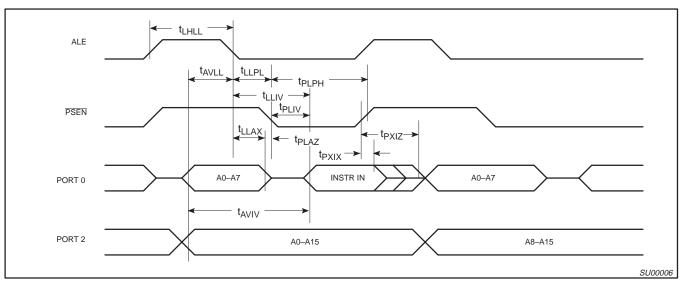


Figure 22. External Program Memory Read Cycle

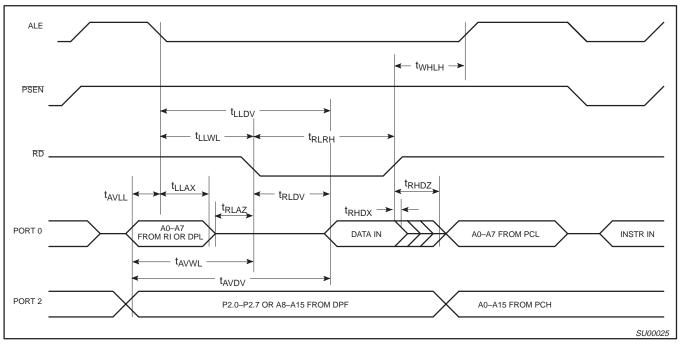


Figure 23. External Data Memory Read Cycle

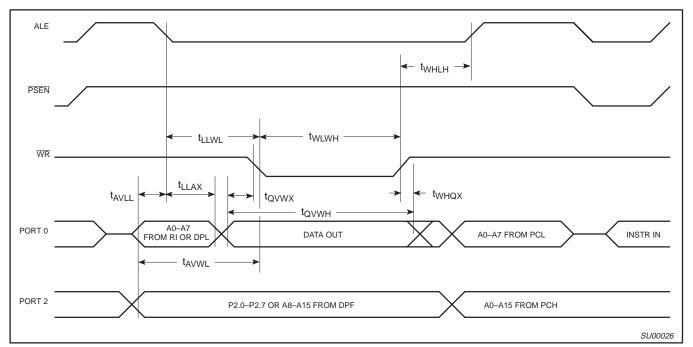


Figure 24. External Data Memory Write Cycle

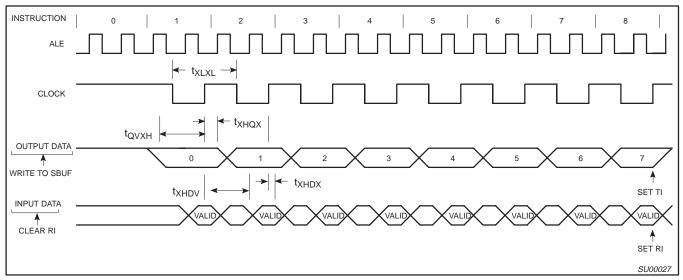


Figure 25. Shift Register Mode Timing

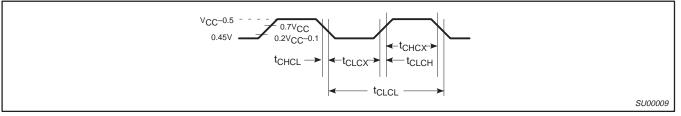
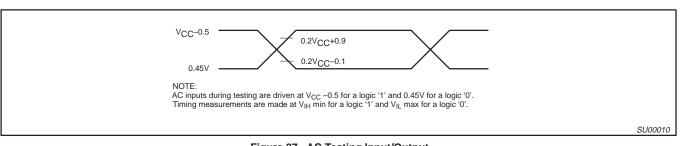
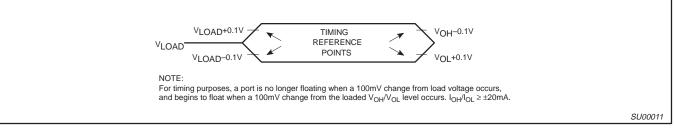


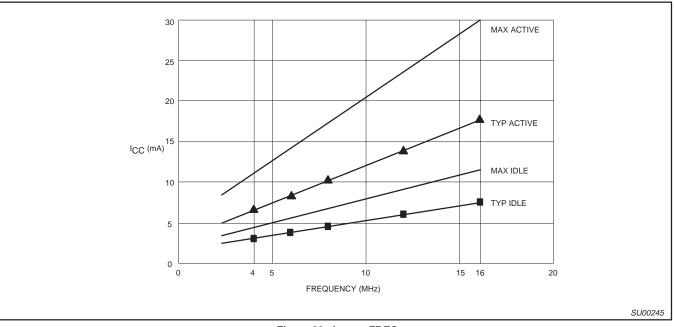
Figure 26. External Clock Drive

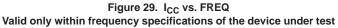












80C575/83C575/87C575

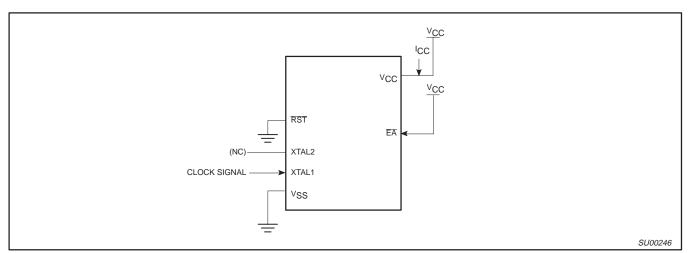


Figure 30. I_{CC} Test Condition, Active Mode All other pins are disconnected

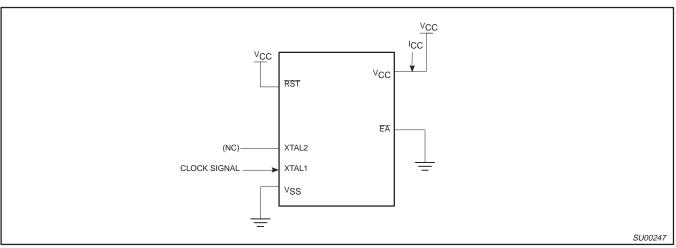
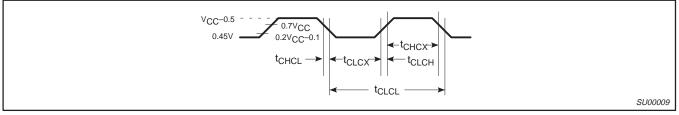
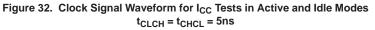


Figure 31. I_{CC} Test Condition, Idle Mode All other pins are disconnected





80C575/83C575/87C575

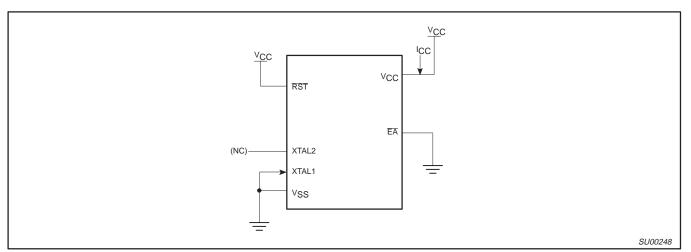


Figure 33. I_{CC} Test Condition, Power Down Mode All other pins are disconnected. V_{CC} = 2V to 5.5V

80C575/83C575/87C575

EPROM CHARACTERISTICS

To put the 87C575 in the EPROM programming mode, PSEN must be held high during power up, then driven low with reset active. The 87C575 is programmed by using a modified Quick-Pulse ProgrammingTM algorithm. It differs from older methods in the value used for V_{PP} (programming supply voltage) and in the width and number of the ALE/PROG pulses.

The 87C575 contains two signature bytes that can be read and used by an EPROM programming system to identify the device. The signature bytes identify the device as an 87C575 manufactured by Philips.

Table 3 shows the logic levels for reading the signature byte, and for programming the program memory, the encryption table, and the security bits. The circuit configuration and waveforms for quick-pulse programming are shown in Figures 34 and 35. Figure 36 shows the circuit configuration for normal program memory verification.

Quick-Pulse Programming

The setup for microcontroller quick-pulse programming is shown in Figure 34. Note that the 87C575 is running with a 4 to 6MHz oscillator. The reason the oscillator needs to be running is that the device is executing internal address and program data transfers. The address of the EPROM location to be programmed is applied to ports 1 and 2, as shown in Figure 34. The code byte to be programmed into that location is applied to port 0. RST, <u>PSEN</u> and pins of ports 2 and 3 specified in Table 3 are held at the 'Program Code Data' levels indicated in Table 3. The ALE/PROG is pulsed low 25 times as shown in Figure 35.

To program the encryption table, repeat the 25 pulse programming sequence for addresses 0 through 1FH, using the 'Pgm Encryption Table' levels. Do not forget that after the encryption table is programmed, verification cycles will produce only encrypted data.

To program the security bits, repeat the 25 pulse programming sequence using the 'Pgm Security Bit' levels. After one security bit is programmed, further programming of the code memory and encryption table is disabled. However, the other security bit can still be programmed.

Note that the \overline{EA}/V_{PP} pin must not be allowed to go above the maximum specified V_{PP} level for any amount of time. Even a narrow glitch above that voltage can cause permanent damage to the device. The V_{PP} source should be well regulated and free of glitches and overshoot.

Program Verification

If security bit 2 has not been programmed, the on-chip program memory can be read out for program verification. The address of the program memory locations to be read is applied to ports 1 and 2 as shown in Figure 36. The other pins are held at the 'Verify Code Data' levels indicated in Table 3. The contents of the address location will be emitted on port 0. External pull-ups are required on port 0 for this operation.

If the encryption table has been programmed, the data presented at port 0 will be the exclusive NOR of the program byte with one of the encryption bytes. The user will have to know the encryption table contents in order to correctly decode the verification data. The encryption table itself cannot be read out.

Reading the Signature Bytes

The signature bytes are read by the same procedure as a normal verification of locations 030H and 031H, except that P3.6 and P3.7 need to be pulled to a logic low. The values are:

(030H) = 15H indicates manufactured by Philips

(B0H) = 97H indicates 87C575

Program/Verify Algorithms

Any algorithm in agreement with the conditions listed in Table 3, and which satisfies the timing specifications, is suitable.

Table 3. EPROM Programming Modes

MODE	RST	PSEN	ALE/PROG	EA/V _{PP}	P2.7	P2.6	P3.7	P3.6
Read signature	0	0	1	1	0	0	0	0
Program code data	0	0	0*	V _{PP}	1	0	1	1
Verify code data	0	0	1	1	0	0	1	1
Pgm encryption table	0	0	0*	V _{PP}	1	0	1	0
Pgm security bit 1	0	0	0*	V _{PP}	1	1	1	1
Pgm security bit 2	0	0	0*	V _{PP}	1	1	0	0

NOTES:

1. 0' = Valid low for that pin, 1' = valid high for that pin.

2. $V_{PP} = 12.75V \pm 0.25V$.

3. $V_{CC} = 5V \pm 10\%$ during programming and verification.

ALE/PROG receives 25 programming pulses while V_{PP} is held at 12.75V. Each programming pulse is low for 100μs (±10μs) and high for a minimum of 10μs.

[™]Trademark phrase of Intel Corporation.

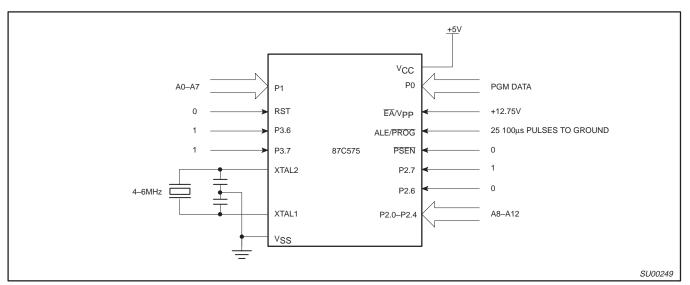


Figure 34. Programming Configuration

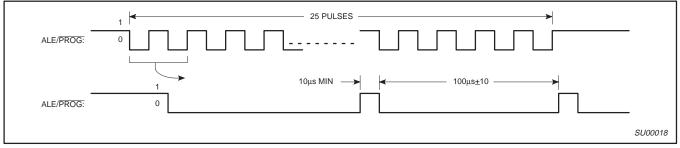


Figure 35. PROG Waveform

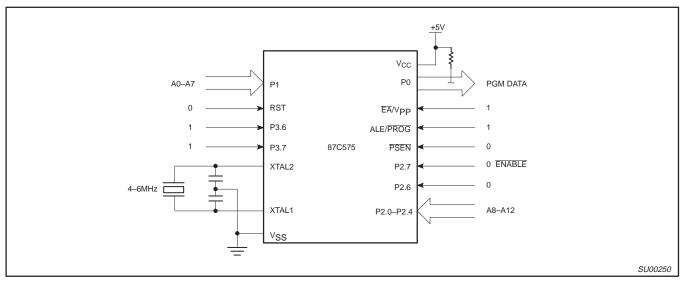


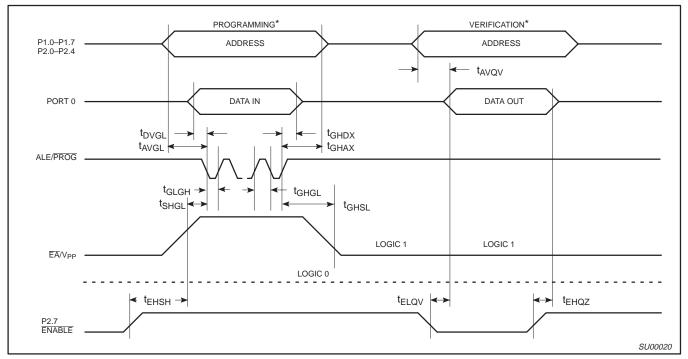
Figure 36. Program Verification

80C575/83C575/87C575

EPROM PROGRAMMING AND VERIFICATION CHARACTERISTICS

 $T_{amb} = 21^{\circ}C$ to +27°C, $V_{CC} = 5V \pm 10\%$, $V_{SS} = 0V$ (See Figure 37)

SYMBOL	PARAMETER	MIN	MAX	UNIT
V _{PP}	Programming supply voltage	12.5	13.0	V
I _{PP}	Programming supply current		50	mA
1/t _{CLCL}	Oscillator frequency	4	6	MHz
t _{AVGL}	Address setup to PROG low	48t _{CLCL}		
t _{GHAX}	Address hold after PROG	48t _{CLCL}		
t _{DVGL}	Data setup to PROG low	48t _{CLCL}		
t _{GHDX}	Data hold after PROG	48t _{CLCL}		
t _{EHSH}	P2.7 (ENABLE) high to V _{PP}	48t _{CLCL}		
t _{SHGL}	V _{PP} setup to PROG low	10		μs
t _{GHSL}	V _{PP} hold after PROG	10		μs
t _{GLGH}	PROG width	90	110	μs
t _{AVQV}	Address to data valid		48t _{CLCL}	
t _{ELQZ}	ENABLE low to data valid		48t _{CLCL}	
t _{EHQZ}	Data float after ENABLE	0	48t _{CLCL}	
t _{GHGL}	PROG high to PROG low	10		μs



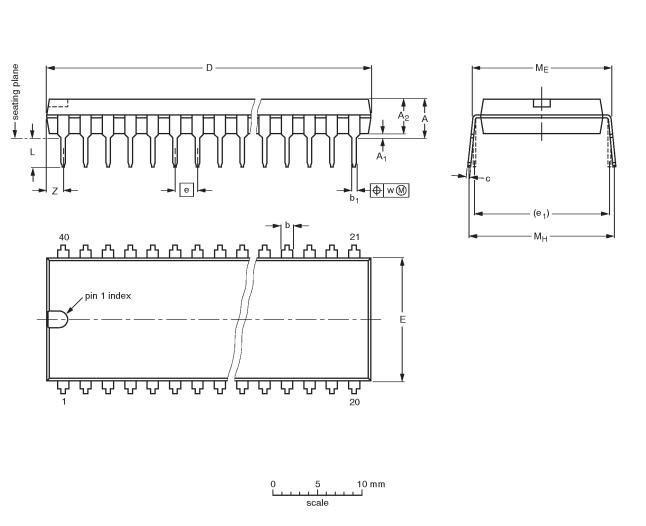
FOR PROGRAMMING VERIFICATION SEE FIGURE 34. FOR VERIFICATION CONDITIONS SEE FIGURE 36.

Figure 37. EPROM Programming and Verification

1998 Jan 27

CMOS single-chip 8-bit microcontrollers

DIP40: plastic dual in-line package; 40 leads (600 mil)



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	Е ⁽¹⁾	е	e ₁	L	M _E	M _H	w	Z ⁽¹⁾ max.
mm	4.7	0.51	4.0	1.70 1.14	0.53 0.38	0.36 0.23	52.50 51.50	14.1 13.7	2.54	15.24	3.60 3.05	15.80 15.24	17.42 15.90	0.254	2.25
inches	0.19	0.020	0.16	0.067 0.045	0.021 0.015	0.014 0.009	2.067 2.028	0.56 0.54	0.10	0.60	0.14 0.12	0.62 0.60	0.69 0.63	0.01	0.089

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

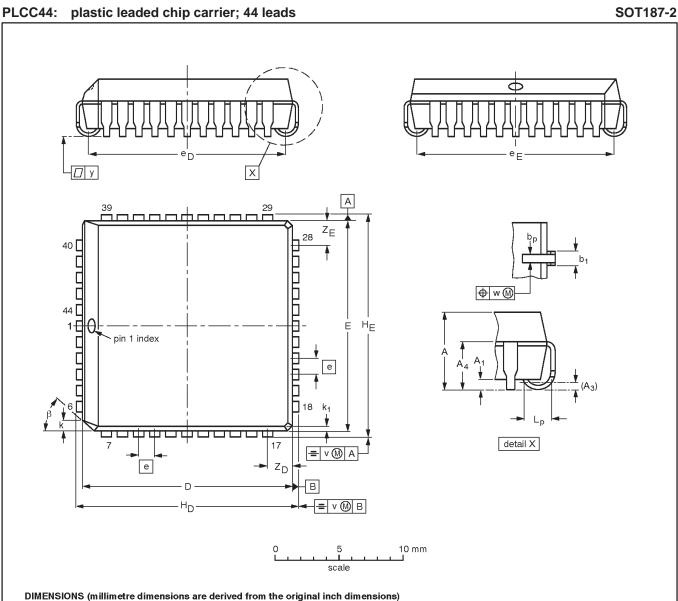
OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1550E DATE	
SOT129-1	051G08	MO-015AJ				-92-11-17 95-01-14	

1118

Product specification

SOT129-1

80C575/83C575/87C575

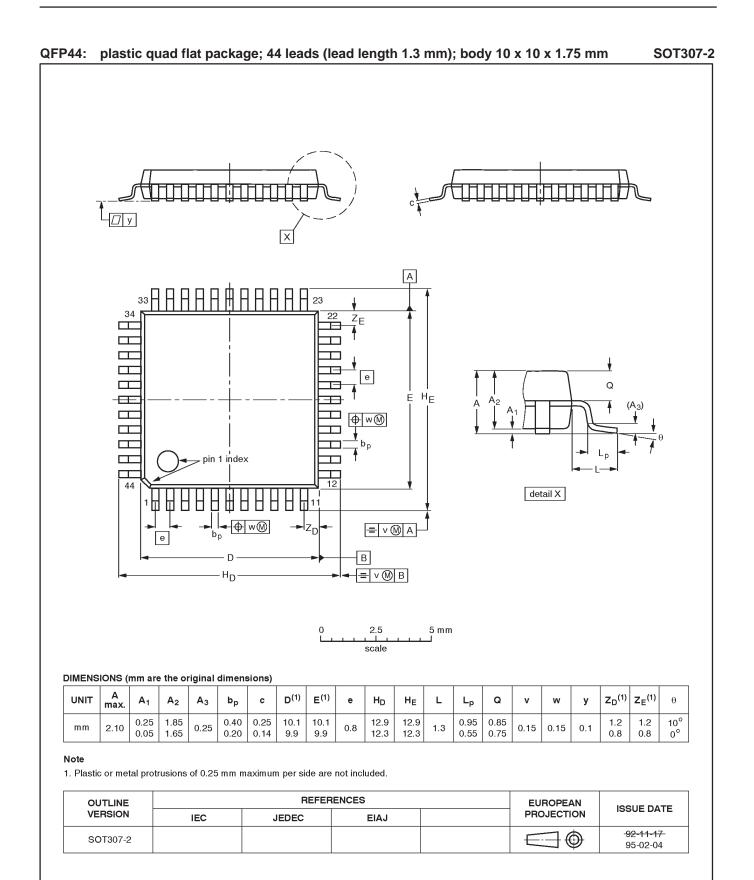


UNIT	А	A ₁ min.	Α3	A ₄ max.	bp	b ₁	D ⁽¹⁾	E ⁽¹⁾	е	е _D	еЕ	H _D	Η _E	k	k ₁ max.	Lp	v	w	у	Z _D ⁽¹⁾ max.		β
mm	4.57 4.19	0.51	0.25	3.05	0.53 0.33	0.81 0.66	16.66 16.51	16.66 16.51	1.27	16.00 14.99			17.65 17.40	1.22 1.07	0.51	1.44 1.02	0.18	0.18	0.10	2.16	2.16	45 ⁰
inches	0.180 0.165	0.020	0.01				0.656 0.650		0.05	0.630 0.590	0.630 0.590	0.695 0.685	0.695 0.685	0.048 0.042	0.020	0.057 0.040		0.007	0.004	0.085	0.085	45

Note

1. Plastic or metal protrusions of 0.01 inches maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT187-2	112E10	MO-047AC				-92-11-17 95-02-25	



80C575/83C575/87C575

NOTES

80C575/83C575/87C575

	DEFINITIONS									
Data Sheet Identification Product Status Definition										
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.								
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.								
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